



# **ORG4600-B01 (SPIDER)**

## **L1 & L5 GNSS Receiver Module**

### **DATASHEET**

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## ABBREVIATIONS

Abbreviation	Description
A-GPS	Assisted GPS
AC	Alternating Current
ADC	Analog to Digital Converter
AGC	Automatic Gain Control
BPF	Band Pass Filter
C/N0	Carrier to Noise density ratio [dB-Hz]
CDM	Charged Device Model
CE	European Community conformity mark
CEP	Circular Error Probability
CMOS	Complementary Metal-Oxide Semiconductor
CPU	Central Processing Unit
CTS	Clear-To-Send
CW	Continuous Wave
DC	Direct Current
DOP	Dilution Of Precision
DR	Dead Reckoning
DSP	Digital Signal Processor
ECEF	Earth-Centered Earth-Fixed
ECHA	European Chemical Agency
EGNOS	European Geostationary Navigation Overlay Service
EIA	Electronic Industries Alliance
EMC	Electro-Magnetic Compatibility
EMI	Electro-Magnetic Interference
ENIG	Electroless Nickel Immersion Gold
ESD	Electro-Static Discharge
ESR	Equivalent Series Resistance
EU	European Union
EVB	Evaluation Board
EVK	Evaluation Kit
FCC	Federal Communications Commission
FSM	Finite State Machine
GAGAN	GPS Aided Geo-Augmented Navigation
GNSS	Global Navigation Satellite System
GPIO	General Purpose Input or Output
GPS	Global Positioning System
HBM	Human Body Model
HDOP	Horizontal Dilution Of Precision
I2C	Inter-Integrated Circuit
I/O	Input or Output
IC	Integrated Circuit

Abbreviation	Description
ICD	Interface Control Document
IF	Intermediate Frequency
ISO	International Organization for Standardization
JEDEC	Joint Electron Device Engineering Council KA (Keep Alive)
KF	Kalman Filter
LDO	Low Dropout regulator
LGA	Land Grid Array
LNA	Low Noise Amplifier
LP	Low Power
LS	Least Squares
LSB	Least Significant Bit
MID	Message Identifier
MM	Machine Model
MSAS	Multi-functional Satellite Augmentation System
MSB	Most Significant Bit
MSL	Moisture Sensitivity Level
NFZ™	Noise-Free Zones System
NMEA	National Marine Electronics Association
NVM	Non-Volatile Memory
PCB	Printed Circuit Board
PLL	Phase Lock Loop
PMU	Power Management Unit
POR	Power-On Reset
PPS	Pulse Per Second
PRN	Pseudo-Random Noise
PSRR	Power Supply Rejection Ratio
PTF™	Push-To-Fix
QZSS	Quasi-Zenith Satellite System
RAM	Random Access Memory
REACH	Registration, Evaluation, Authorization and Restriction of Chemical substances
RF	Radio Frequency
RHCP	Right-Hand Circular Polarized
RMS	Root Mean Square
RoHS	Restriction of Hazardous Substances directive
ROM	Read-Only Memory
RTC	Real-Time Clock
RTS	Ready-To-Send
SAW	Surface Acoustic Wave
SBAS	Satellite-Based Augmentation Systems
SID	Sub-Identifier
SIP	System In Package
SMD	Surface Mounted Device

Abbreviation	Description
SMPS	Switched Mode Power Supply
SMT	Surface-Mount Technology
SOC	System On Chip
SPI	Serial Peripheral Interface
SV	Satellite Vehicle
TCXO	Temperature-Compensated Crystal Oscillator
TTF	Time To First Fix
TTL	Transistor-Transistor Logic
UART	Universal Asynchronous Receiver/Transmitter
VCCI	Voluntary Control Council for Interference by information technology equipment
VEP	Vertical Error Probability
VGA	Variable-Gain Amplifier
WAAS	Wide Area Augmentation System

## RELATED DOCUMENTATION

Nº	Document Name
1	ORG4600-B01 Evaluation Kit Datasheet

## REVISION HISTORY

Revision	Date	Change Description	Author
1.0	February 26, 2019		Ron T.
1.1	August 4, 2020	Updated mechanical specifications Updated IO voltage rate Updated default firmware Updated current consumption	Igor M.
1.2	November 22, 2020	Update Ordering Information	Ron T.
1.3	February 15, 2021	Update satellites constellations Added 1PPS	Igor M.
1.4	July 25, 2022	Update accuracy and dynamic constrains	Igor M.



## SCOPE

This document describes the features and specifications of the ORG4600-B01 GNSS receiver module.

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## SAFETY INFORMATION



Improper handling or misuse of the product can cause permanent damage.

This product is an electronic sensitive device (ESD) and must be handled with care.

## DISPOSAL INFORMATION



This product must not be treated as household waste.

For more detailed information about recycling electronic components, contact your local waste-management authority.

## CONTACT INFORMATION

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## 1. ABOUT SPIDER FAMILY

OriginGPS GNSS receiver modules have been designed to address markets where size, weight, stand-alone operation, high levels of integration, power consumption, and design flexibility are all of the utmost importance. The OriginGPS Spider family breaks the size barrier, offering the industry's smallest fully-integrated, highly-sensitive GPS / GNSS modules.

Spider modules feature OriginGPS proprietary NFZ™ technology for high sensitivity and noise immunity even under marginal signal condition commonly found in urban canyons, under dense foliage, or when the receiver's position in space changes rapidly.

The Spider family enables the shortest TTM (Time-to-Market) with minimal design risks. Just connect an antenna and power supply on a 2-layer PCB and you're good to go.

## 2. ABOUT ORG4600-B01 MODULE

The OR4600 module is a complete SiP that features a miniature LGA SMT footprint designed to commit unique integration features for high volume, cost sensitive applications.

Designed to support compact and traditional applications such as smart watches, wearable devices, asset trackers, the ORG4600-B01 module is a miniature, multi-channel GPS, Galileo and GLONASS, BeiDou, QZSS, IRNSS (NAVIC) in both the L1/B1/E1 and L5/E5a overlay systems receiver that continuously tracks all satellites in view, providing real-time positioning data in industry's standard NMEA format.

The ORG4600-B01 module offers superior sensitivity and outstanding performance, achieving rapid TTFF in less than one second with an accuracy of approximately one meter and tracking sensitivity of -167dBm.

With a size of only 10mm x 10mm, the ORG4600-B01 module is industry's smallest-sized, record breaking solution.

The ORG4600-B01 module introduces the industry's lowest energy-per-fix ratio, unparalleled accuracy and extremely rapid fixes even under challenging signal conditions such as in built-up urban areas, dense foliage, or even indoors.

An integrated GNSS SoC incorporates a high-performance microprocessor and sophisticated firmware that keeps positioning payload off the host, enabling integration in embedded solutions with low computing resources.

Innovative architecture can detect changes in context, temperature, and satellite signals to achieve a state of near continuous availability by maintaining and opportunistically updating its internal fine time, frequency, and satellite ephemeris data while consuming mere microwatts of battery power.

### 3. **ABOUT ORIGINGPS**

OriginGPS is a world leading designer, manufacturer, and supplier of miniature positioning modules, antenna modules, antenna solutions, and IoT devices.

OriginGPS develops fully integrated, miniaturized GPS/GNSS and integrated IoT solutions for developers. OriginGPS modules introduce unparalleled sensitivity and noise immunity by incorporating Noise-Free-Zone system (NFZ™) proprietary technology for faster position fixing and navigation stability even under challenging satellite signal conditions.

Founded in 2006, OriginGPS specializes in developing unique technologies that miniaturize RF modules, thereby addressing the market need for smaller wireless solutions. For over a decade, our experts have been developing ultra-sensitive, reliable, high performance modules with the smallest footprint on the market, supporting a range of categories, such as asset tracking, fleet management, industrial IoT, law enforcement, pet/people tracking, precise agriculture, smart cities, sports and wearables.

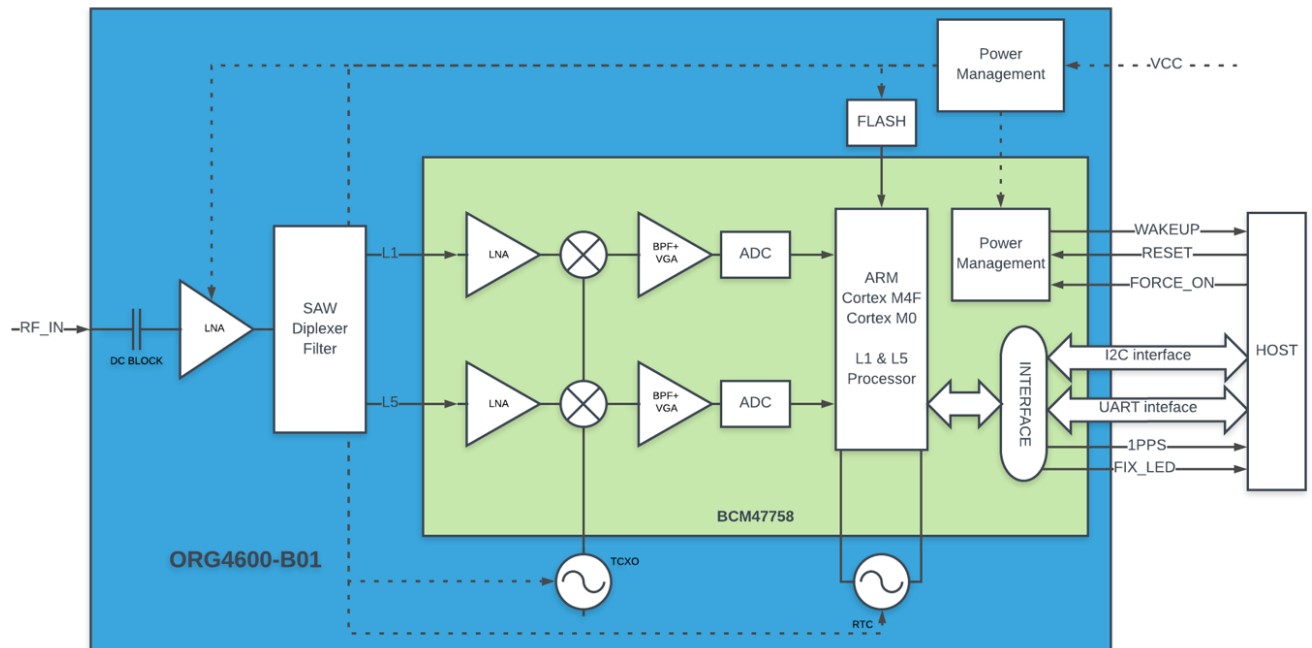
## 4. DESCRIPTION

### 4.1. Features

The ORG4600-Bo1 module includes the following features.

- Autonomous operation
- OriginGPS Noise Free Zone System (NFZ™) technology
- Active or Passive antenna support
- Fully integrated dual-stage LNA, Diplexer Filter, TCXO, RTC, GNSS SoC, LDO, RF shield, and PMU
- Uses simultaneously GPS, Galileo and GLONASS, BeiDou, QZSS, IRNSS (NAVIC) both in L1/B1/E1 and L5/E5a
- Concurrent tracking of multiple constellations
- 99 search channels and 32 simultaneous tracking channels
- Ultra-high sensitivity down to -167dBm
- High accuracy of < 1m in 67% of trials
- High accuracy of 10cm@CEP, open sky conditions during 24 hours
- AGPS support: CBEE, LTO (TBD)
- Indoor and outdoor Multipath and cross-correlation mitigation
- Jamming Rejection
- 250KB built-in flash
- Power management modes: Sleep, Standby, Ultra Low Power
- NMEA and RAW Data output with PORC commands over UART
- High update messages rate of 1Hz, 5Hz
- Static navigation
- Variable voltage supply 2-5.5V input
- Ultra-small LGA footprint of 10mm x 10mm
- Ultra-low weight of 0.42g
- Surface Mount Device (SMD)
- Optimized for automatic assembly and reflow equipment
- Operating temperatures from -40°C to +85°C
- RED compliant
- RoHS III certificate
- REACH compliant

## 4.2. Architecture



**Figure 1. ORG4600-B01 Architecture**

The ORG4600-B01 module includes the following main components.

- **GNSS Diplexer SAW Filter**

Band-Pass SAW diplexer filter (L1&L5) eliminates out-of-band signals that may interfere with GNSS reception. The GNSS SAW filter is optimized for low Insertion Loss in GNSS band and low Return Loss outside of it.

- **GNSS LNA**

Dual-stage cascaded LNAs amplify GNSS signals to meet RF down converter input threshold.

Noise Figure optimized design was implemented to provide maximum sensitivity.

- **TCXO**

Highly stable 26MHz oscillator controls the down conversion process in the RF block of the GNSS SoC.

Characteristics of this component are important factors for higher sensitivity, shorter TTFF, and improved navigation stability.

- **RTC Crystal**

The RTC 32.768 KHz quartz crystal with very tight specifications is required to maintain Hot Start and Warm Start capabilities of the module.

- **RF Shield**

The RF enclosure avoids external interference from compromising sensitive circuitry inside the module.

The RF shield also blocks the module's internal high frequency emissions from being radiated.

- **Internal LDO**

The LDO provides a regulated voltage supply over a wide input voltage range, with low quiescent current and high PSRR.

- **Flash**

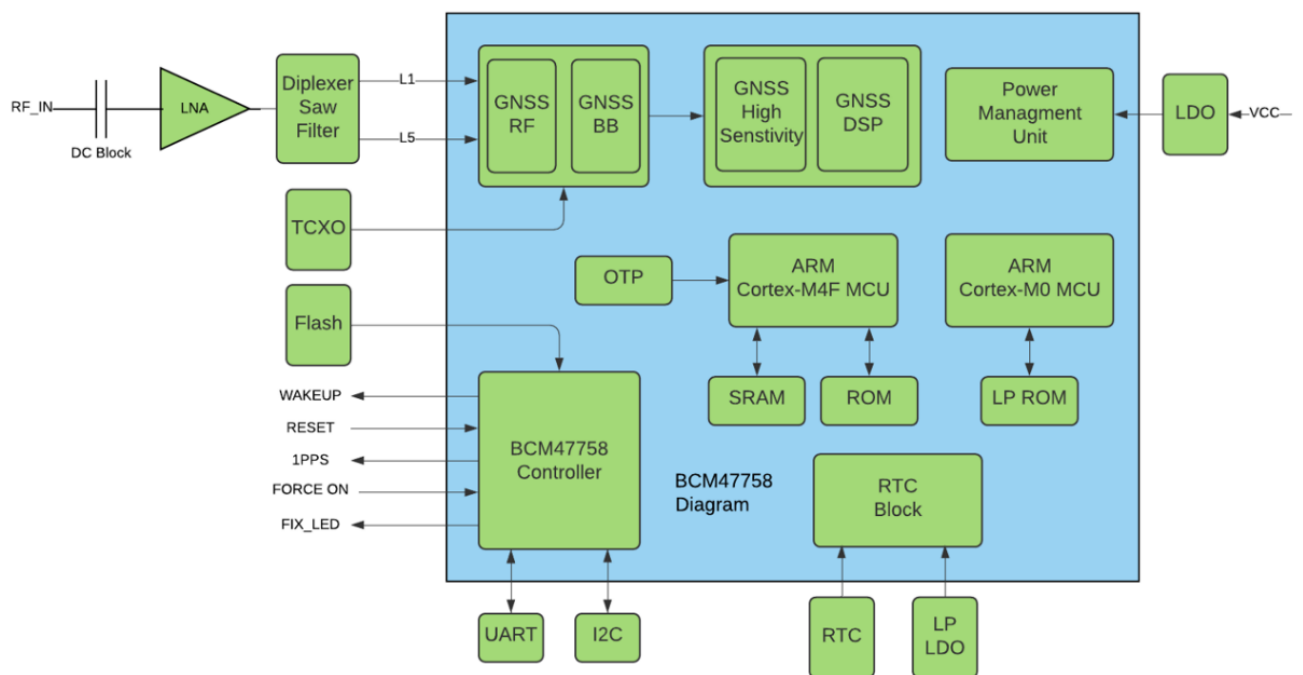
A 250KB built-in flash that boots firmware from the flash for independent operation.

- **BCM47758 GNSS SoC**

The chip is a dual-band multi-GNSS System on Chip designed by Broadcom.

This is a hybrid positioning processor that combines L1 and L5 GPS, Galileo and GLONASS, BeiDou, QZSS, and IRNSS (NAVIC) to provide a high-performance navigation solution.

The BCM47758 is a full SoC built on a low-power RF CMOS that incorporates GNSS RF, GNSS baseband, integrated navigation solution software, ARM CM4+CM0 dual-processor, and serial flash.



**Figure 2. BCM47758 System Block Diagram and Peripheral**

The BCM47758 SoC includes the following units:

- GNSS radio subsystem containing dual receive paths for concurrent multi-channel GPS, Galileo and GLONASS, BeiDou, QZSS, IRNSS (NAVIC) in both the L1/B1/E1 and L5/E5a, mixer with current mode interface between the mixer and multi-modes low pass filter, fractional-N synthesizer, integrated self-calibrating filters, IF VGA with AGC, and high-sample rate ADCs with adaptive dynamic range.

- Measurement subsystem including a DSP core for GNSS signals acquisition and tracking, interference scanner and detector, interference removers, multipath and cross-correlation detectors, dedicated DSP code ROM, and DSP cache SRAM Measurement subsystem interfaces a GNSS radio subsystem.
- Navigation subsystem comprising an ARM Cortex-M4F microprocessor system for position, velocity and time solution, program ROM, data SRAM, OTP, and flash.
- Peripheral Controller subsystem containing UART Host interface, RTC block, wake up signal option, and GPIO.
- Peripheral Controller subsystem that interfaces with the navigation subsystem, PLL, and PMU subsystems.
- Navigation subsystem that interfaces with the measurement subsystem.
- PMU subsystem containing voltage regulators for RF and baseband domains.



## 4.3. ORG4600-B01 Features Description

### 4.3.1. Assisted GPS (AGPS)

Assisted GPS (or Aided GPS) is a method by which TTFF is reduced using information from a source other than broadcast GPS signals. The necessary ephemeris data is calculated either by the receiver itself (locally generated ephemeris) or a server (server-generated ephemeris) and stored in the module.

#### 4.3.1.1. LTO - Long Term Orbit

Long Term Orbit (LTO) technology brings GPS assistance data to mobile device users who do not have the benefit of Assisted-GPS (A-GPS) infrastructure in their wireless networks.

GPS-enabled mobile devices equipped with LTO deliver AGPS-enhanced performance without sacrificing the freedom of autonomous operation. GPS receivers typically require clear lines of sight to the satellites to download the orbit data (ephemeris) that is required for computing a position.

- Autonomous GNSS decodes the info from the satellites, taking typically 6-10s to decode time, ~60s to decode ephemeris, and assuming the center of the Earth as estimated position. This leads to poor Time to First Fix (TTFF) and poor sensitivity.
- Long Term Orbits (LTO) provides info on all satellite ephemeris, valid for 7 days. Broadcom's on-chip SRAM (state is maintained in Idle mode) provides time and estimated position from previous fixes to improve both TTFF and sensitivity.
- LTO is a 150kB file that is generated in the OriginGPS server. Receivers around the world and customer applications can download it via HTTP or HTTPS. TTFF and sensitivity are both greatly improved.

#### 4.3.1.2. CBEE - Client-Based Extended Ephemeris

Client-Based Extended Ephemeris (CBEE) is an ephemeris prediction generated at the client for GPS satellites in view at the time of generation. The CBEE algorithm runs in the background with low priority while the GNSS device is powered. The computation time is approximately three seconds per satellite.

- The main purpose of the CBEE is to improve TTFF.
- The CBEE is valid for a duration of 24 hours.
- The size of the CBEE is 3 KB/satellite.
- The accuracy degradation of the CBEE is ~10m after 24 hours, which is under 0.5m/hour.

#### 4.3.2. QZSS - Quasi-Zenith Satellite System

The three satellites of the Japanese SBAS are in a highly inclined elliptical orbit which is geosynchronous (not geostationary) and has analemma-like ground tracks. This orbit provides continuous coverage over Japan using only three satellites. Their primary purpose is to provide augmentation to the GPS system, but the signals may also be used for ranging. NMEA reporting for QZSS may be enabled/disabled by the user.

#### 4.3.3. Power Management Modes

The ORG4600-B01 supports operational modes that enable them to provide positioning information at reduced overall current consumption. Availability of GNSS signals in the operating environment is also a factor in the choice of power management modes. The designer can choose a mode that provides the best

trade-off for performance versus power consumption.

The power management modes are described below, and can be enabled by command:

- Full Power Continuous - for optimal GNSS performance.
- Power Save modes to optimize power consumption.

##### 4.3.3.1. Full Power Continuous Mode

The modules start up in full power continuous mode. This mode uses the acquisition engine at full performance resulting in the shortest possible TTFF and the highest sensitivity. It searches for all possible satellites. The receiver then switches to the tracking engine to lower the power consumption when:

- A valid GPS/GNSS position is obtained.
- The ephemeris for each satellite in view is valid.

#### **4.3.3.2. Ultra-Low Power**

The Ultra-Low Power mode disables the input power to the BCM internal PMU except to the low-power regulator for RTC and bootup. In this power mode there is no dropout voltage on the regulators to maximize the power consumption.

\* For more information, refer to the FORCE\_ON section or to the commands description section.

#### **4.3.4. Configuration Settings**

Configuration settings are erased when power is turned off.

## 5. PAD ASSIGNMENTS

**Table 1. Pin Out**

Pad	Name	Function	Direction	Logic level
1	GPIO	General Purposes Input Output	Bi-directional	1.8V
2	TX	UART Transmit (Serial Output)	Output	1.8V
3	RX	UART Receive (Serial Input)	Input	1.8V
4	CTS	UART Clear To Send	Input	1.8V
5	RTS	UART Ready To Send	Output	1.8V
6	EXTI	External Interrupt	Input	1.8V
7	GND	System Ground	Power	
8	GND	System Ground	Power	
9	RF L1/L5	RF Input	Input	50Ω
10	GND	System Ground	Power	
11	RESERVED	Future Use RF Input	Input	50Ω
12	GND	System Ground	Power	
13	GND	System Ground		
14	WAKUP	WAKEUP	Output	1.8V
15	ADC	Analog to Digital Convertor	Input	1.8V
16	FIX_LED	FIX_LED	Output	1.8V
17	RESET	System Reset	Input	1.8V
18	FORCE_ON	Forced full-power mode signal	Input	1.8V
19	1PPS	UTC Time Mark	Output	1.8V
20	GND	System Ground	Power	1.8V
21	SDA	I2C Data	Bi-directional	1.8V
22	V <sub>CC</sub>	System Power	Power	2-2.5V
23	SCL	I2C Clock	Bi-directional	1.8V
24	GPIO	General Purposes Input Output	Bi-directional	1.8V
25	GND	System Ground	Power	

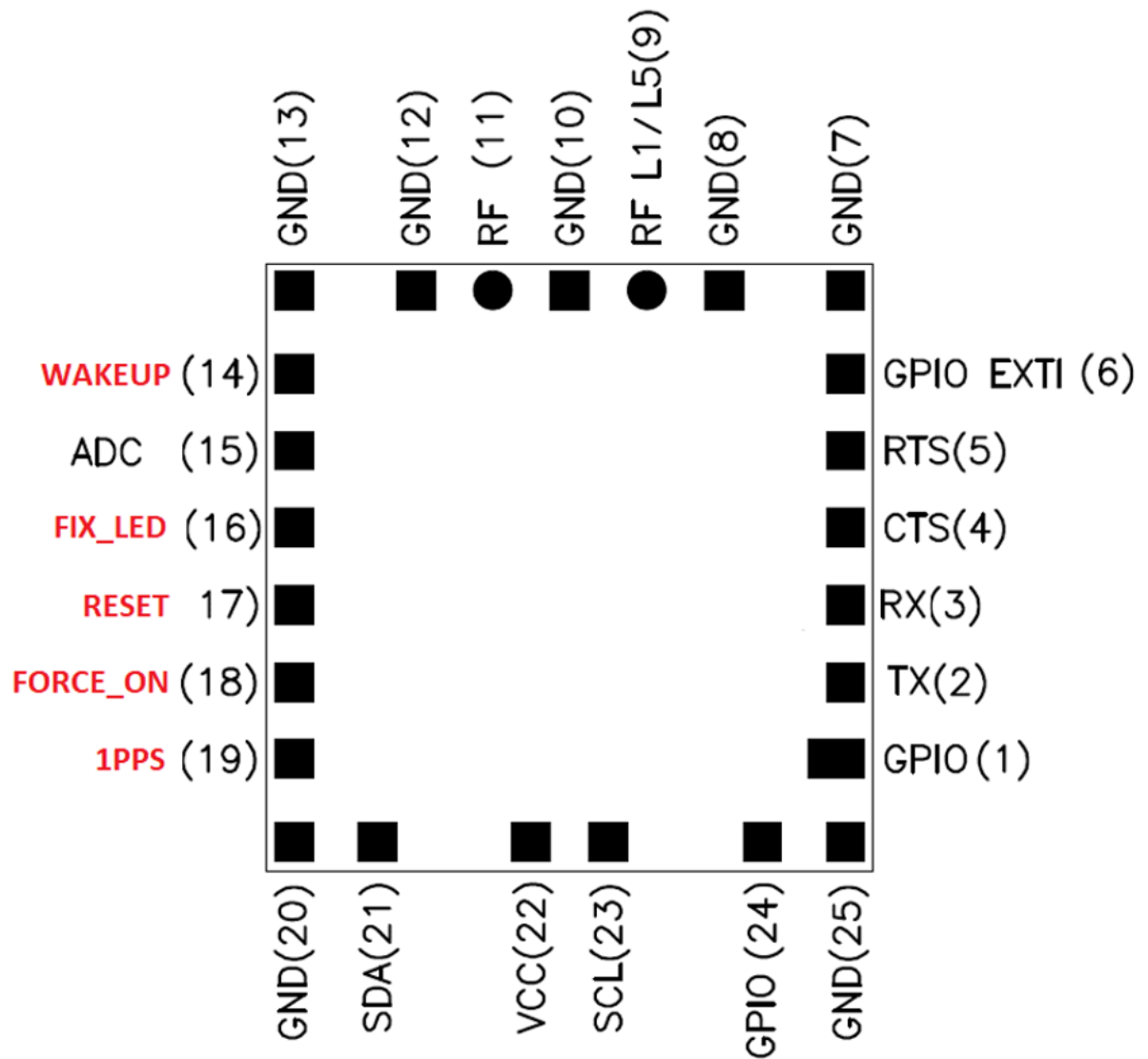


Figure 3. ORG4600-B01 Top View

## 6. MECHANICAL SPECIFICATIONS

The mechanical specifications of the ORG4600-B01 module are listed below.

- The ORG4600-B01 module has miniature LGA SMD packaging sized 10mm x 10mm.
- The ORG4600-B01 is built on a PCB assembly enclosed with a metallic RF shield box.
- On the bottom side of the unit there are 25SMT pads with a base and ENIG plating.
- The ORG4600-B01 module supports automated pick and place assembly and reflow soldering processes.

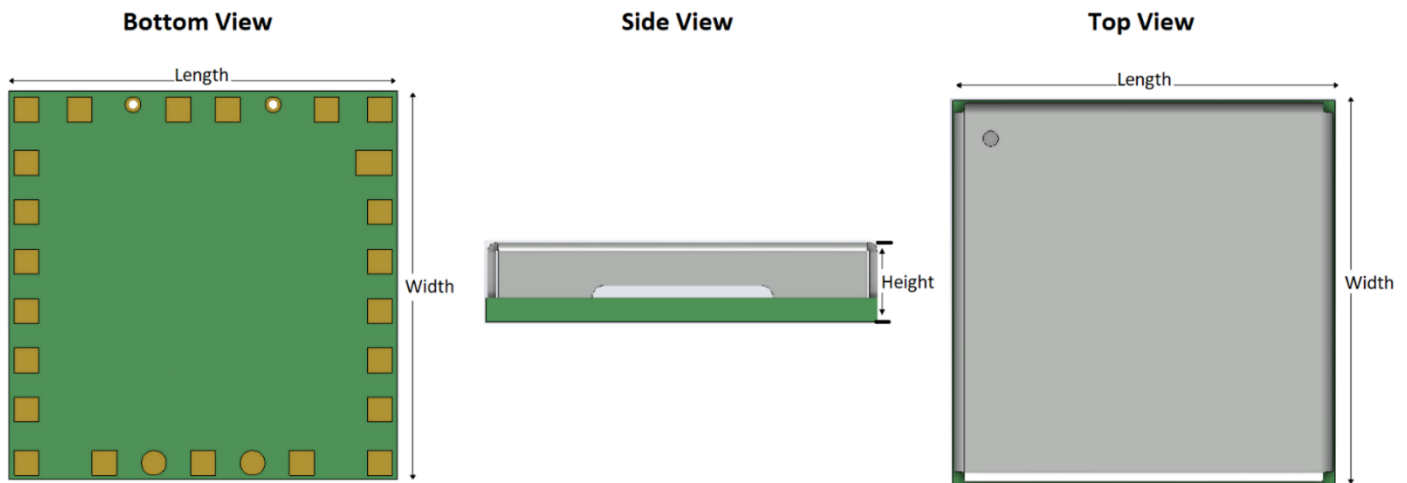


Figure 4. Mechanical Drawing

Table 2. Mechanical Dimensions - Summary

Dimensions	Length	Width	Height	Weight	
mm	10.0 + 0.1 / -0.05	10.2 + 0.1 / -0.05	1.75 + 0.1 / -0.05	gr	0.42
inch	0.394 + 0.004 / -0.002	0.402 + 0.004 / -0.002	0.069 + 0.004 / -0.002	oz	0.015

## 7. ELECTRICAL SPECIFICATIONS

### 7.1. Absolute Maximum Ratings

Stresses exceeding Absolute Maximum Ratings may damage the device.

**Table 3. Absolute Maximum Ratings**

Parameter		Symbol	Min	Max	Unit
Power Supply Voltage		$V_{CC}$	-0.30	+6	V
Power Supply Current <sup>1</sup>		$I_{CC}$		200	mA
I/O Voltage		$V_{IO}$	-0.30	+3.3	V
I/O Source/Sink Current		$I_{IO}$		+8	mA
ESD Voltage		$V_{IO/RF, HBM\ 2}$		2000	V
		$V_{IO/RF, MM3}$		250	V
RF Power <sup>4</sup>	$f_{IN} = 1160\text{MHz} \div 1630\text{MHz}$	$P_{RF}$		+0	dBm
Operating Temperature <sup>5</sup>		$T_{AMB}$	-45	+90	°C

**Notes:**

- I. Inrush current for about 20 $\mu$ s duration.
- II. Human Body Model (HBM) contact discharge per EIA/JEDEC JESD22-A114D. Step: 500V (+/-).
- III. Machine Model (MM) contact discharge per EIA/JEDEC JESD22-A115C. Step: 50V (+/-).
- IV. Power delivered to antenna element.
- V. Lead temperature at 1mm from case for 10s duration.

## 7.2. Recommended Operating Conditions

Exposure to stresses above Recommended Operating Conditions may affect device reliability.

**Table 4. Recommended Operating Conditions**

Parameter	Symbol	Mode/Pad	Test Conditions	Min	Typ	Max	Unit
Power supply voltage	V <sub>CC</sub>	V <sub>CC</sub>		+2		+5.5	V
Digital IO Pin Low level input voltage	V <sub>IL</sub>				0	+0.54	V
Digital IO Pin High level input voltage	V <sub>IH</sub>			+1.26	+1.8	+3.3	V
Digital IO Pin Low level output voltage	V <sub>OL</sub>		I <sub>OL</sub> =8mA		0	+0.45	V
Digital IO Pin High level output voltage	V <sub>OH</sub>		I <sub>OH</sub> =8mA	+1.35	+1.8		V
Power Supply Current <sup>1</sup>	I <sub>CC</sub>	Acquisition			48		mA
		Tracking			37		mA
		Ultra-Low Power			30		μA
Input Impedance (L1)	Z <sub>IN</sub>	RF Input	F <sub>in</sub> = 1575.42MHz		50		Ω
Input Return Loss (L1)	R <sub>LIN</sub>			-7			dB
Input Impedance (L5)	Z <sub>IN</sub>		F <sub>in</sub> = 1176.45MHz		50		Ω
Input Return Loss (L5)	R <sub>LIN</sub>			-7			dB
Input Power Range	P <sub>IN</sub>			-167			dBm
Input Frequency Range	f <sub>IN</sub>			1166		1217	MHz
Input Frequency Range	f <sub>IN</sub>			1559		1605	MHz
Operating Temperature	T <sub>AMB</sub>			-40	+25	+85	°C



## 8. PERFORMANCE

### 8.1. Acquisition Time

TTFF (Time to First Fix) – is the period of time from the module's power-up until valid position estimation.

#### 8.1.1. Hot Start

Hot Start results either from a software reset after a period of continuous navigation or a return from a short idle period that was preceded by a period of continuous navigation. During Hot Start, all critical data (position, velocity, time, and satellite ephemeris) is valid to the specified accuracy and availability in RAM.

#### 8.1.2. Signal Reacquisition

Reacquisition follows temporary blocking of GNSS signals.

The typical reacquisition scenario includes driving through a tunnel.

#### 8.1.3. Aided Start

Aided Start is a method of effectively reducing TTFF by providing valid satellite ephemeris data. Aiding can be implemented with CBEE and LTO.

#### 8.1.4. Warm Start

Warm Start typically results from user-supplied position and time initialization data or continuous RTC operation with an accurate last known position available in RAM. In this state position and time data are present and valid, but satellite ephemeris data validity has expired.

#### 8.1.5. Cold Start

Cold Start occurs when satellite ephemeris data, position, and time data are unknown. A typical Cold Start scenario includes a first power application.

**Table 5. Acquisition Time**

Operation <sup>1</sup>	Value	Unit
Hot Start	< 15	s
Aided Start <sup>2</sup>	< 4	s
Warm Start	< 30	s
Cold Start	< 35	s
Signal Reacquisition <sup>3</sup>	< 3	s

**Notes:**

- I. EVK is 24-hrs. It is static under signal conditions of -130dBm and ambient temperature of +25°C.
- II. Tested on the EVB with conducted conditions
- III. Outage duration ≤ 30s for reacquisition.

## 8.2. Sensitivity

### 8.2.1. Tracking

Tracking is an ability of the receiver to maintain valid satellite ephemeris data.

During tracking, the receiver may stop the output of valid position solutions.

Tracking sensitivity is defined as the minimum GNSS signal power required for tracking.

### 8.2.2. Reacquisition

Reacquisition follows temporary blocking of GNSS signals.

Reacquisition sensitivity is defined as the minimum GNSS signal power required for reacquisition.

### 8.2.3. Navigation

During navigation, the receiver consequently outputs valid position solutions.

Navigation sensitivity is defined as the minimum GNSS signal power required for reliable navigation.

### 8.2.4. Hot Start

Hot Start sensitivity is defined as the minimum GNSS signal power required for a valid position solution under Hot Start conditions.

### 8.2.5. Aided Start

Aided Start sensitivity is defined as the minimum GNSS signal power required for a valid position solution following the aiding process.

### 8.2.6. Cold Start

Cold Start sensitivity is defined as the minimum GNSS signal power required for a valid position solution under Cold Start conditions, sometimes referred to as the ephemeris decode threshold.

## 8.3. Received Signal Strength

**Table 6. Received Signal Strength**

Parameter <sup>4</sup>	Value	Unit
C/N <sub>0</sub>	48	dB-Hz

## 8.4. Position Accuracy

**Table 7. ORG4600-B01 Position Accuracy**

Parameter	95% (m)	67%(m)
Horizontal Position Accuracy	2.7	0.9

## 8.5. Dynamic Constraints

**Table 8. Dynamic Constraints**

Parameter	Metric	Imperial
Velocity	600m/s	1,166knots
Altitude	160km	524934 ft
Acceleration	4g	

**Note:** Standard dynamic constraints according to regulatory limitations.

## 9. CONTROL INTERFACE

### 9.1. Power Supply

It is recommended to keep the power supply on all the time to maintain the RTC block active and keep satellite data in RAM for the fastest possible TTFF. When  $V_{CC}$  is removed, settings are reset to the factory default and the receiver performs a Cold Start on the next power up.

#### 9.1.1. Nominal $V_{CC}$ = 2-5.5V

A variable  $V_{CC}$  operates from 2V to 5.5V DC and must be provided from a regulated power supply.

During tracking, the processing is less intense compared to acquisition, therefore the power consumption is lower.

Filtering is important in managing high alternating current flows on the power input connection. An additional LC filter on the ORG4600-B01 power input may be required to reduce system noise.

The high rate of the ORG4600-B01 input current change requires low ESR bypass capacitors.

Additional higher ESR output capacitors can provide input stability damping.

The ESR and size of the output capacitors directly define the output ripple voltage with a given inductor size. Large low ESR output capacitors are beneficial for low noise.

#### 9.1.2. Ground

Ground pad must be connected to a host PCB Ground with the shortest possible trace or by multiple VIAs.

### 9.2. Interface

#### 9.2.1. UART- Host Interface

The ORG4600-B01 has the following standard UART ports:

##### 9.2.1.1. TX

TX is used for GPS data reports. The TX serial data line outputs NMEA serial data. When no serial data is output, the TX data line idles high.

##### 9.2.1.2. RX

RX is used for receiver control. The RX data line accepts OriginGPS proprietary protocol commands.

## 9.2.2. Data Interface

### 9.2.2.1. Force-On

FORCE\_ON is an input signal that can be used to wake up the ORG4600-B01 from the Power Save Mode, bringing it to Full Power mode. The module wakes up when FORCE\_ON is in a High-level state.

The module enters Ultra Low Power Mode when FORCE\_ON is in a low-level state. Please refer to OriginGPS proprietary protocol commands.

### 9.2.2.2. Reset

External reset is available through the  $\overline{\text{RESET}}$  pad. Active low signal.

The module continuously monitors the VCC supply and issues an internal hardware reset if the voltage drops below 2.1 ( $\pm 0.1\text{V}$ ). This reset protects the memory from accidental writes during a power down condition. To prevent this, the supply must be regulated to within the 2.0-5.5V voltage range, inclusive of load regulation and power supply noise and ripple. Noise and ripple outside of these limits can affect positioning sensitivity and risk tripping the internal voltage supervisors, thereby shutting down the module unexpectedly. Regulators with good load regulation are recommended in order to prevent power supply glitches as the receiver transitions between power states.

### 9.2.2.3. Wakeup

When the ORG4600-B01 is in Full Power and Sleep Mode, the output will be in a high-level state.

When the ORG4600-B01 is in Standby mode and Ultra-Low Power Mode, the output will be in a low-level state.

### 9.2.2.4. 1PPS

By default, 1PPS is disabled since it may consume more current consumption. For enabling the 1PPS please refer to the suitable SW manual.

## 10. TYPICAL APPLICATION CIRCUIT

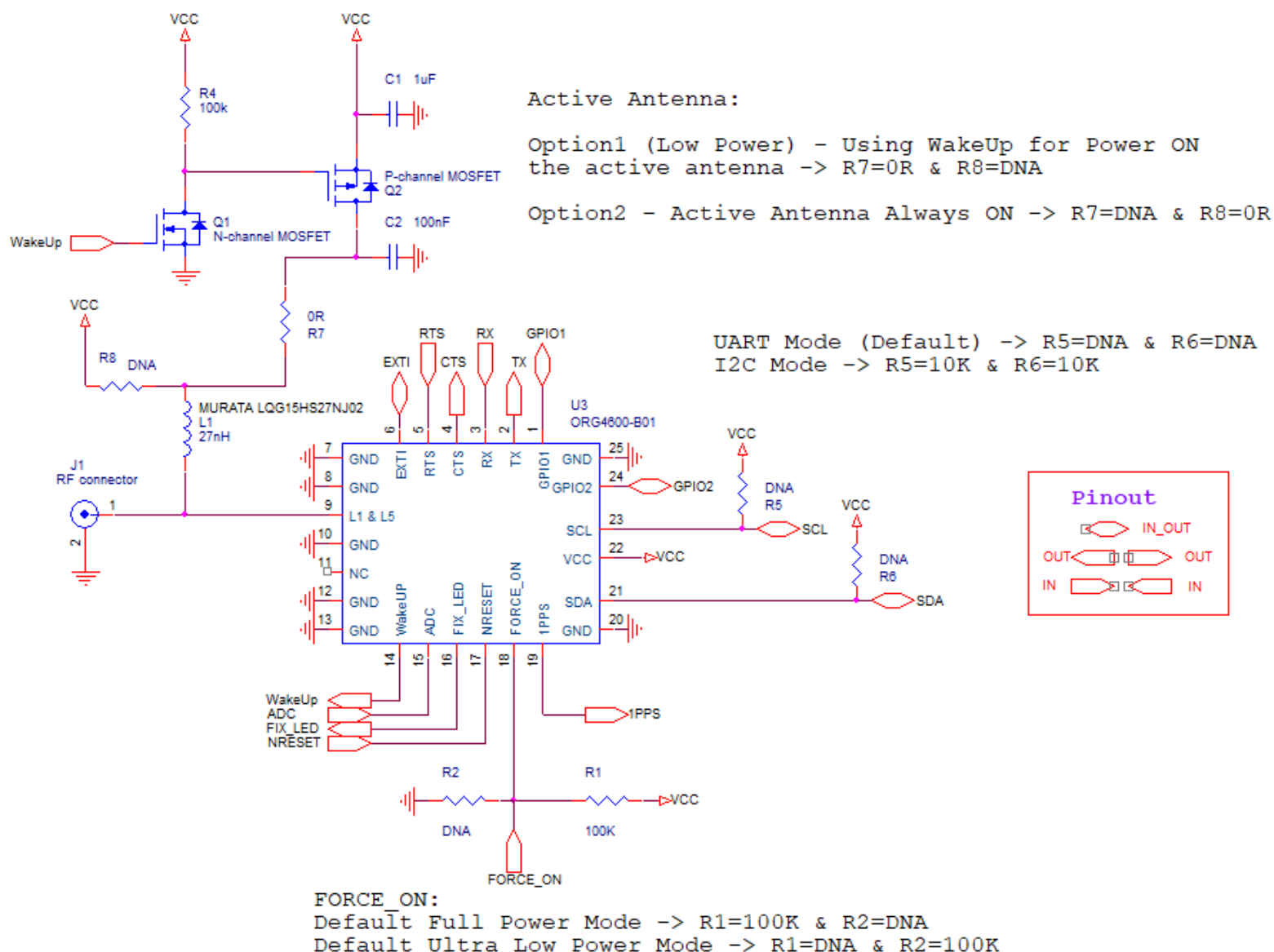
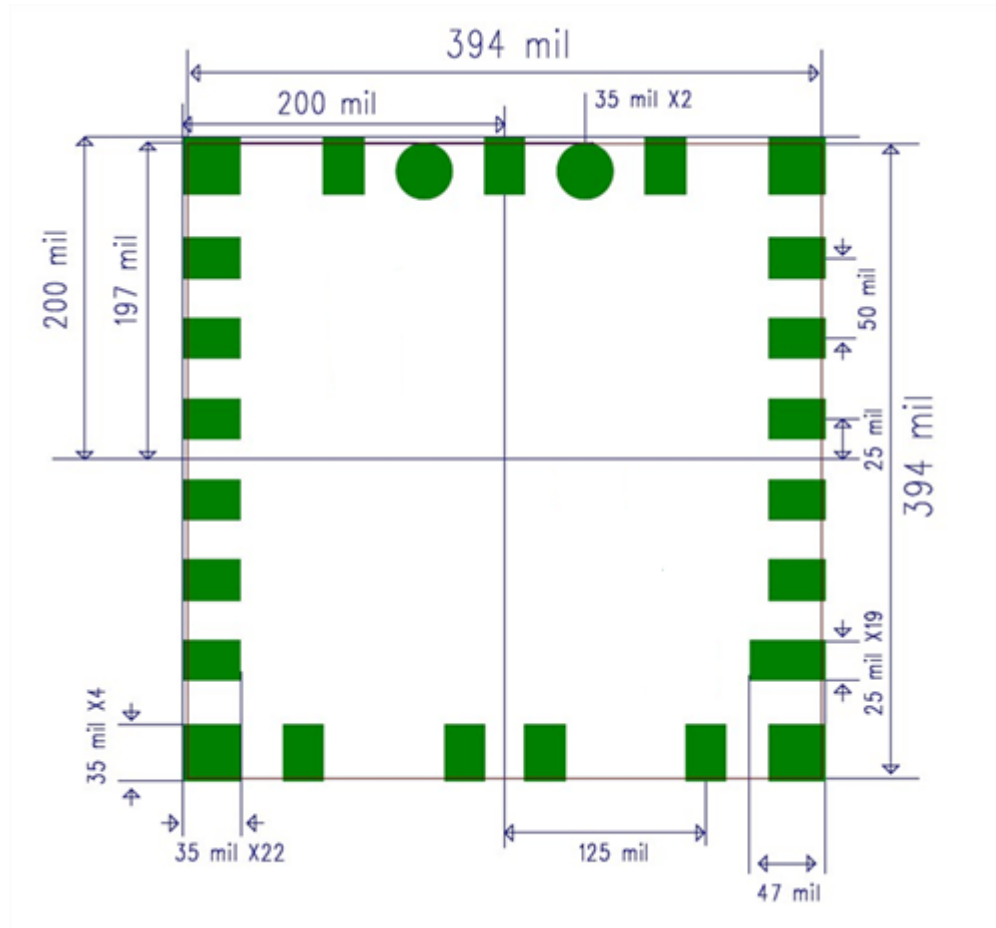


Figure 5. Reference Schematic Diagram

## 11. RECOMMENDED PCB LAYOUT

### 11.1. Footprint



**Figure 6. Footprint**

**Note:** A silk print of the module's outline is recommended for SMT visual inspections.

## 11.2. Host PCB

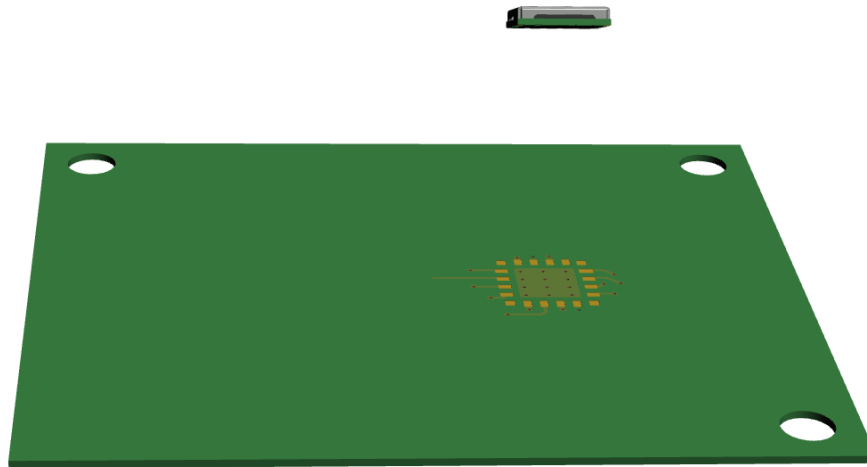


Figure 7. Host PCB

## 11.3. RF Trace

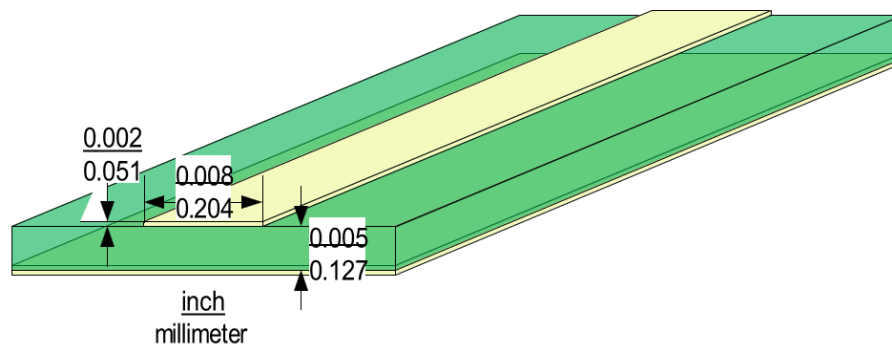


Figure 8. Typical Microstrip PCB Trace On FR-4 Substrate

## 11.4. PCB Stack-Up

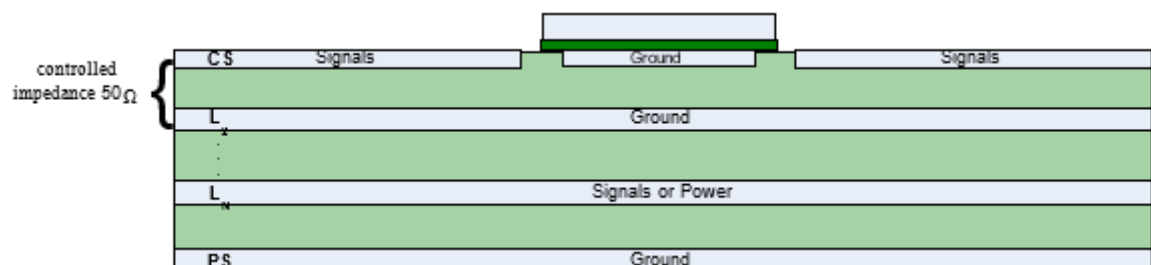


Figure 9. Typical PCB Stack-Up



## 11.5. PCB Layout Restrictions

Switching and high-speed components, traces, and VIAs must be kept away from the ORG4600-B01 module. Signal traces to/from module must have minimum length.

Recommended minimal distance from adjacent active components is 3mm. Ground pads must be connected to the host PCB Ground with the shortest possible traces or VIAs.

In the event of a tight integration constraint or co-location with adjacent high-speed components like CPU or memory, high frequency components like transmitters, clock resonators or oscillators, LCD panels or CMOS image sensors, contact: [ContactUs@OriginGPS.com](mailto:ContactUs@OriginGPS.com) for application specific recommendations.

## **12. DESIGN CONSIDERATIONS**

### **12.1. Antenna**

Antennas for GPS, Galileo, and GLONASS have a wider bandwidth than pure GPS antennas.

Some wideband antennas may not have a good axial ratio to block reflections of RHCP GPS, Galileo, and GLONASS signals. These antennas have lower rejection of multipath reflections and tend to degrade the overall performance of the receiver.

#### **12.1.1. Passive Antenna**

Design with a passive antenna requires RF layout skills and can be challenging.

#### **12.1.2. Active Antenna**

While designing with an active antenna, it is worth considering using the WAKEUP output to control the auxiliary DC bias.

### **12.2. RF**

The ORG4600-B01 operates with received signal levels down to -167dBm and can be affected by high absolute levels of RF signals, moderate levels of RF interference near the GNSS bands, and by low levels of RF noise in the GNSS band.

RF interference from nearby electronic circuits or radio transmitters can contain enough energy to desensitize ORG4600-B01. These systems may also produce levels of energy outside of the GNSS band, which are high enough to leak through RF filters and degrade the operation of the radios in ORG4600-B01.

This issue becomes more critical in small products, where there are industrial design constraints. In those environments, transmitters for Wi-Fi, Bluetooth, RFID, cellular, and other radios may have antennas physically close to the GNSS receiver antenna.

To prevent degraded performance of ORG4600-B01, OriginGPS recommends performing EMI/jamming susceptibility tests for radiated and conducted noise on prototypes and assessing risks of other factors.

## 13. FIRMWARE UPDATES

Default FW configuration:

- L1 and L5 Full satellites support.
- Constellation – GPS, Galileo, GLONASS.
- UART baud rate - 115200 bps.
- Monitoring FORCE\_ON on startup.
- Ultra-Low Power Mode.
- 1PPS disabled by default.
- OriginGPS Proprietary Protocol Commands. (section 18)

The FW stored in the internal Flash memory may be upgraded.

To update the FW, contact us.

[contactus@origingps.com](mailto:contactus@origingps.com)    [www.origingps.com](http://www.origingps.com)

## 14. HANDLING INFORMATION

### 14.1. Moisture Sensitivity

ORG4600-B01 modules are MSL 3 designated devices according to the IPC/JEDEC J-STD-033B standard.

Modules in sample or bulk packaging should be baked prior to assembly at 125°C for 48 hours.

### 14.2. Assembly

The module supports automatic pick-and-place assembly and reflow soldering processes.

Suggested solder paste stencil is 5 mil to ensure sufficient solder volume.

### 14.3. Soldering

Reflow soldering of the module always on the component side (Top side) of the host PCB according to standard IPC/JEDEC J-STD-020D for LGA SMD.

Avoid exposure of the ORG4600-B01 to face-down the reflow soldering process.

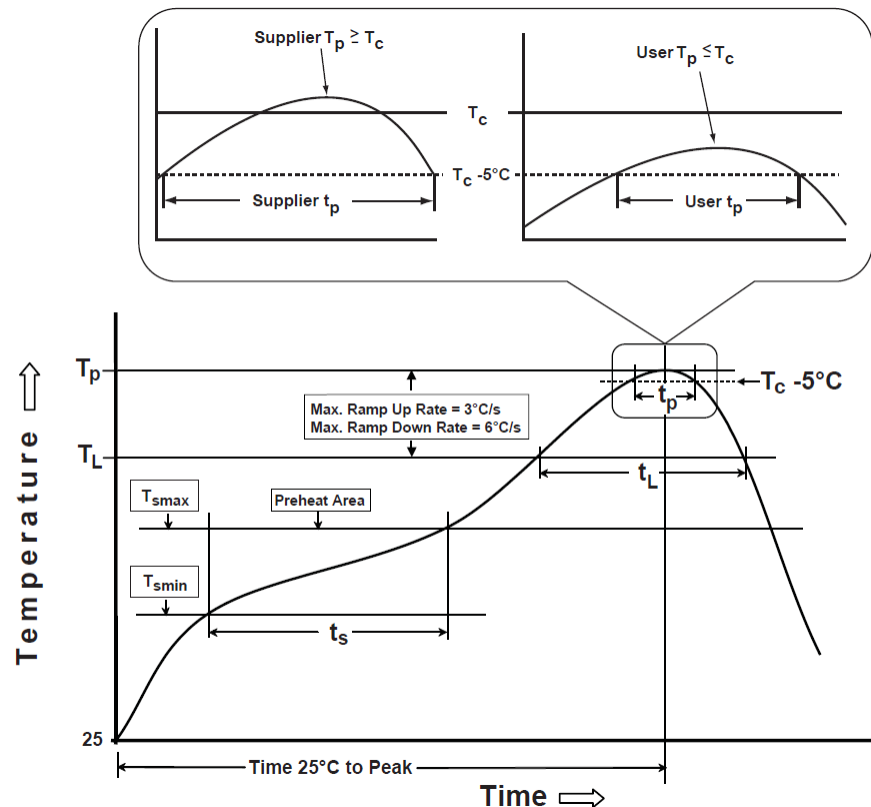


Figure 10. Recommended Soldering Profile

#### Notes:

- I. The referred temperature is measured on the top surface of the package during the entire soldering process.
- II. The suggested peak reflow temperature is 245°C for 30 sec. for Pb-Free solder paste.
- III. The actual board assembly reflow profile must be developed individually per furnace characteristics.
- IV. Reflow furnace settings depend on the number of heating/cooling zones, type of solder paste/flux used, board design, component density, and packages used.

**Table 9. Soldering Profile Parameters**

Symbol	Parameter	Min	Typ	Max	Unit
T <sub>C</sub>	Classification Temperature		245		°C
T <sub>P</sub>	Package Temperature			245	°C
T <sub>L</sub>	Liquidous Temperature		217		°C
T <sub>S</sub>	Soak/Preheat Temperature	150		200	°C
t <sub>S</sub>	Soak/Preheat Time	60		120	s
t <sub>L</sub>	Liquidous Time	60		150	s
t <sub>P</sub>	Peak Time		30		s

## 14.4. Cleaning

If flux cleaning is required, the module is capable of withstanding a standard cleaning process in a vapor degreaser with Solvon® n-Propyl Bromide (NPB) solvent and/or washing in DI water.

Avoid the cleaning process in an ultrasonic degreaser, since specific vibrations may cause performance degradation or destruction of internal circuitry.

## 14.5. Rework

If localized heating is required to rework or repair the module, precautionary methods are necessary to avoid exposure to solder reflow temperatures that can result in permanent damage to the device.

## 14.6. Safety Information

Improper handling and use can cause permanent damage to the product. This product is ESD sensitive device and must be handled with care.



## 14.7. Disposal Information

This product must not be treated as household waste.

For more detailed information about recycling electronic components contact your local waste management authority.



## 15. COMPLIANCE

The following standards are applied on production of ORG4600-B01 modules:

- IPC-6011/6012 Class2 for PCB manufacturing
- IPC-A-600 Class2 for PCB inspection
- IPC-A-610D Class2 for SMT acceptability

ORG4600-B01 modules are manufactured in ISO 9001:2008 accredited facilities.

ORG4600-B01 modules are manufactured in ISO 14001:2004 accredited facilities.

ORG4600-B01 modules are manufactured in OHSAS 18001:2007 accredited facilities.

ORG4600-B01 modules are designed, manufactured, and handled in compliance with the Directive 2015/65/EU of the European Parliament and of the Council of June 2011 on the Restriction of the use of certain Hazardous Substances in electrical and electronic equipment, referred to as RoHS III.



ORG4600-B01 modules are manufactured and handled in compliance with the applicable substance bans as of Annex XVII of Commission Regulation (EU) 2018/1881 on Registration, Evaluation, Authorization, and Restriction of Chemicals including all amendments and candidate list issued by ECHA, referred to as REACH.

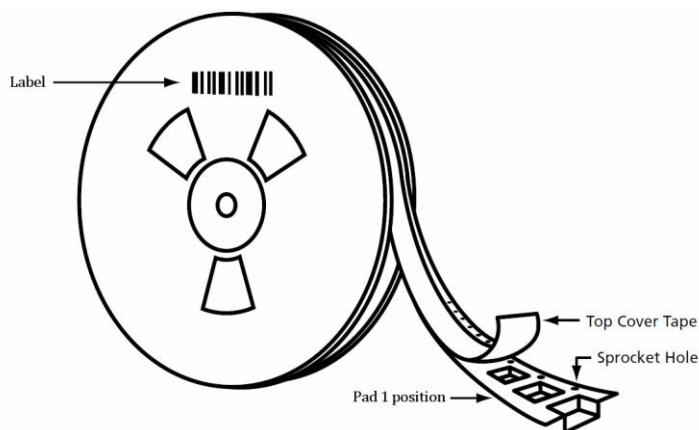


ORG4600-B01 modules are handled in compliance with the EU directive 2014/53/EU dealing with the placing on the market of radio-electric equipment, as per the EU directive from 13 June 2017.

## 16. PACKAGING AND DELIVERY

### 16.1. Appearance

ORG4600-B01 modules are delivered in reeled tapes for an automatic pick and place assembly process.



**Figure 11. Module Position**

ORG4600-B01 modules are packed in two different tape reel quantities.

**Table 10. Reel Quantity**

Suffix	Tape Reel 1 (TR1)	Tape Reel 2 (TR2)
Quantity	300	1200

Reels are dry-packed with a humidity indicator card and desiccant bag according to the IPC/JEDEC J-STD-033B standard for MSL 3 devices.

Reels are vacuum-sealed inside anti-static moisture barrier bags.

Sealed reels are labeled with MSD stickers providing information about:

- MSL
- Shelf life
- Reflow soldering peak temperature
- Seal date

Sealed reels are packed inside cartons.

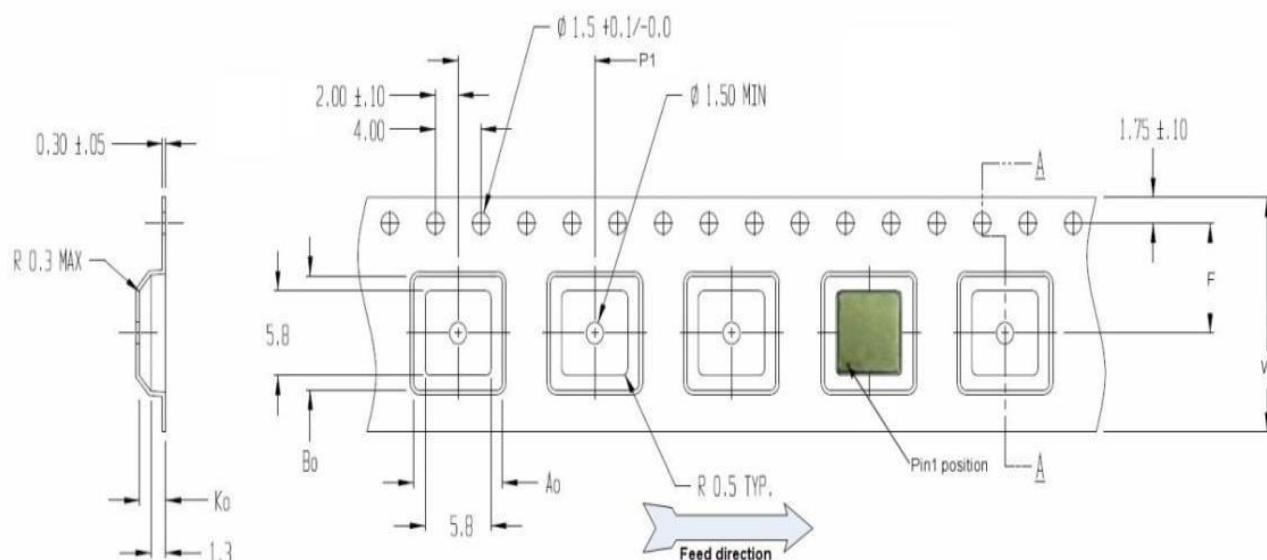
Reels, reel packs, and cartons are labeled with sticker providing information about:

- Description
- Part number
- Lot number
- Customer PO number
- Quantity
- Date code

## 16.2. Carrier Tape

Carrier tape material—polystyrene with carbon (PS+C).

Cover tape material—polyester-based film with heat-activated adhesive coating layer.



**Figure 12. Carrier Tape**

**Table 11. Carrier Tape Dimensions**

	MM	Inch
A <sub>0</sub>	10.9 ± 0.1	0.429 ± 0.004
B <sub>0</sub>	10.7 ± 0.1	0.421 ± 0.004
K <sub>0</sub>	3 ± 0.1	0.240 ± 0.004
P1	12.0 ± 0.1	0.472 ± 0.004
W	16.0 ± 0.3	0.630 ± 0.012



## 16.3. Reel

Reel material—anti-static plastic.

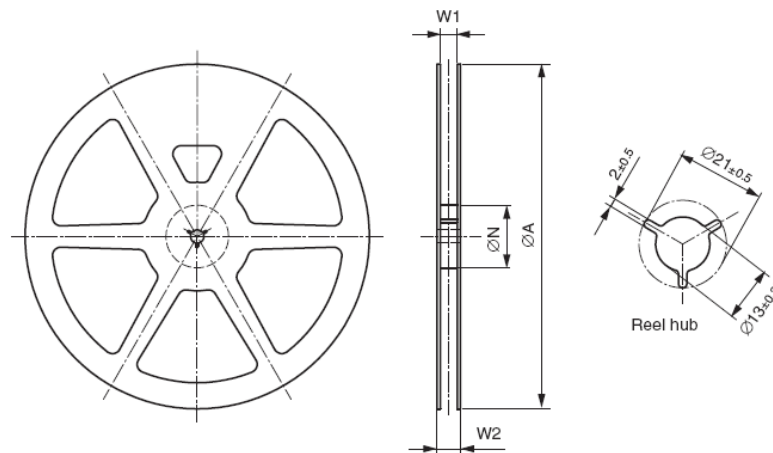


Figure 13. Reel

Table 12. Reel Dimensions

Suffix	TR1		TR2	
	MM	Inch	MM	Inch
ØA	180.0 ± 2.0	7.08 ± 0.08	330.0 ± 2.0	13.0 ± 0.08
ØN	60.0 ± 2.0	2.36 ± 0.08	102.0 ± 2.0	4.02 ± 0.08
W1	16.4 + 2.0 / -0	0.64 + 0.08/-0	8.4 ± 0.5	0.66 ± 0.02
W2	16.4 +3.0 / -0.5	0.64 +0.12/0.02	10.8 ± 0.2	0.42 ± 0.08

## 17. ORDERING INFORMATION

The ORG4600-B01 module is ordered according to the following methodology.

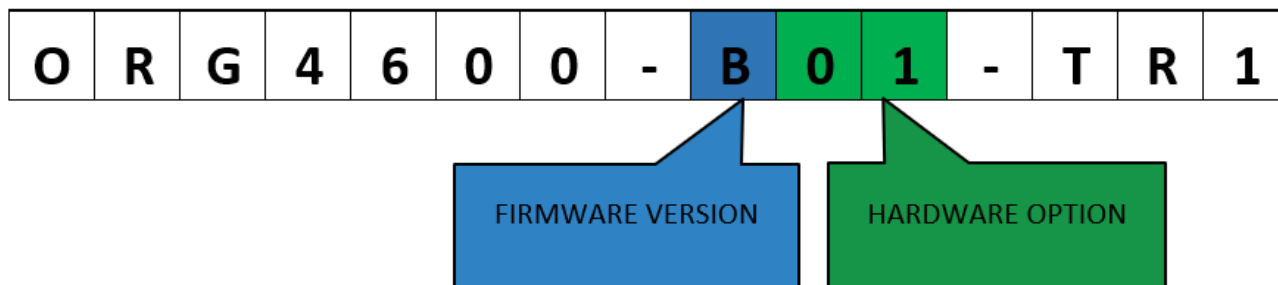


Figure 14. Ordering Options

Table 13. Orderable Devices

Part Number	FW Version	HW Option	VCC Range	Packaging	SPQ
ORG4600-B01-TR1	B	01	2-5.5V	Reeled tape	300
ORG4600-B01-TR2	B	01	2-5.5V	Reeled tape	1200
ORG4600-B01-UAR	B	01	5V USB	Evaluation kit	1
ORG4600-B01-USB	B	01	5V USB	GNSS ON A STICK	1

## 18. ORIGINGPS PROPRIETARY PROTOCOL COMMANDS

OriginGPS developed special commands that enable the customer to implement the ORG4600-B01 in the easiest and quickest way without any knowledge of GPS/GNSS.

For additional information:

[contactus@origingps.com](mailto:contactus@origingps.com) [www.origingps.com](http://www.origingps.com)